#### NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE0125Al uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

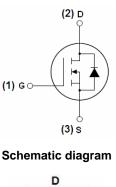
- $V_{DS} = 100V, I_D = 25A$  $R_{DS(ON)} < 36mΩ @ V_{GS} = 10V$  (Typ:31 mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

#### **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!









TO-251 top view

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0125AI	NCE0125AI	TO-251	-	-	-

#### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Symbol	Parameter	Limit	Unit
V <sub>DS</sub>	Drain-Source Voltage	100	V
V <sub>G</sub> s	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current-Continuous	25	А
I <sub>D</sub> (100℃)	Drain Current-Continuous(TC=100°C)	17.6	Α
I <sub>DM</sub>	Pulsed Drain Current	70	Α
P <sub>D</sub>	Maximum Power Dissipation	70	W
	Derating factor	0.5	W/℃
E <sub>AS</sub>	Single pulse avalanche energy (Note 5)	110	mJ
$T_{J}, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	$^{\circ}$ C



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# NCE0125AI

#### **Thermal Characteristic**

$R_{ heta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	2	°C/W	
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# Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

	Symbol	Parameter	Condition	Min	Тур	Max	Unit
Off Character	istics			•			
BV <sub>DSS</sub>	Drain-Source Break	down Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	110	-	V
I <sub>DSS</sub>	Zero Gate Voltage I	Orain Current	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA
I <sub>GSS</sub>	Gate-Body Leaka	ge Current	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA
On Character	istics (Note 3)			1			
V <sub>GS(th)</sub>	Gate Threshold	l Voltage	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	1.6	2.2	V
R <sub>DS(ON)</sub>	Drain-Source On-Sta	ite Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =15A	-	31	36	mΩ
<b>g</b> FS	Forward Transco	nductance	V <sub>DS</sub> =5V,I <sub>D</sub> =15A	-	12	-	S
Dynamic Cha	racteristics (Note4)	1		1			
C <sub>lss</sub>	Input Capac	itance		-	3000	-	PF
C <sub>oss</sub>	Output Capac	citance	$V_{DS}$ =50V, $V_{GS}$ =0V,	-	92	-	PF
C <sub>rss</sub>	Reverse Transfer (	Capacitance	F=1.0MHz	-	18.3	-	PF
Switching Ch	aracteristics (Note 4)	1		l .			
t <sub>d(on)</sub>	Turn-on Dela	y Time		-	9	-	nS
t <sub>r</sub>	Turn-on Rise	Time	$V_{DD}$ =50 $V$ , $R_L$ =5 $\Omega$	-	9	-	nS
$t_{d(off)}$	Turn-Off Dela	y Time	$V_{GS}$ =10V, $R_{GEN}$ =3 $\Omega$	-	31	-	nS
t <sub>f</sub>	Turn-Off Fal	Time		-	9	-	nS
Qg	Total Gate C	harge	)/ F0)/  OFA	-	70.4	-	nC
Q <sub>gs</sub>	Gate-Source	Charge	$V_{DS}=50V, I_{D}=25A,$	-	9.0	-	nC
Q <sub>gd</sub>	Gate-Drain C	Charge	V <sub>GS</sub> =10V	-	15.3	-	nC
Drain-Source	Diode Characteristics	1		•	1		
V <sub>SD</sub>	Diode Forward Vo	oltage (Note 3)	V <sub>GS</sub> =0V,I <sub>S</sub> =25A	-	-	1.2	V
Is	Diode Forward Cu		-	-	-	25	Α
t <sub>rr</sub>	Reverse Recov	ery Time	TJ = 25°C, IF = 25A	-	34	-	nS
Qrr	Reverse Recove	ry Charge	$di/dt = 100A/\mu s^{(Note3)}$	_	56	-	nC

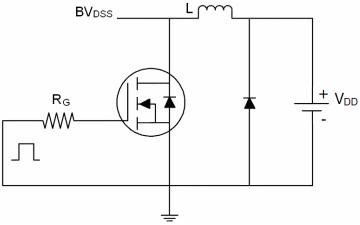
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS Condition : Tj=25  $^{\circ}\text{C}$  ,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$

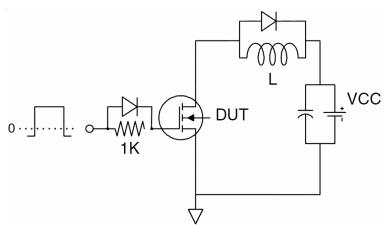


### **Test Circuit**

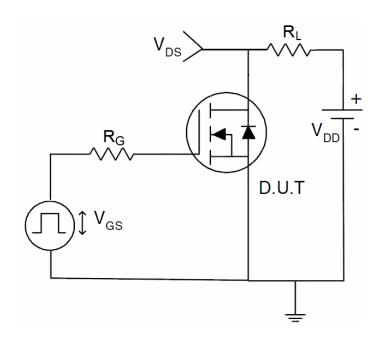
# 1) E<sub>AS</sub> Test Circuit



# 2) Gate Charge Test Circuit

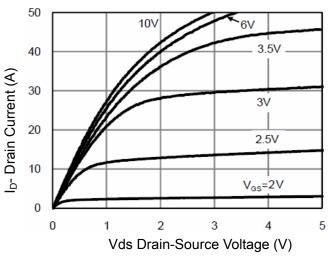


# 3) Switch Time Test Circuit

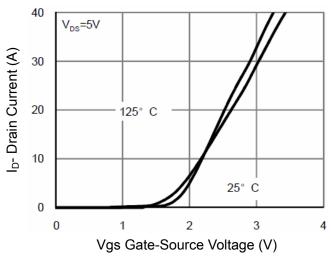




### **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

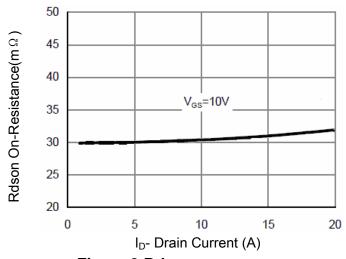


Figure 3 Rdson- Drain Current

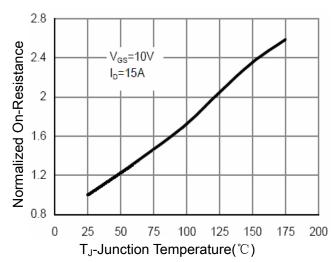
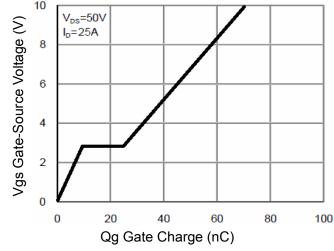


Figure 4 Rdson-JunctionTemperature



**Figure 5 Gate Charge** 

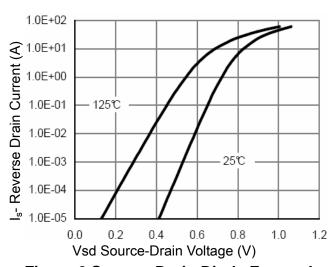


Figure 6 Source- Drain Diode Forward



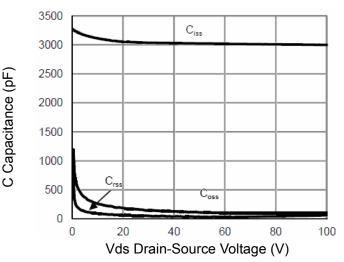


Figure 7 Capacitance vs Vds

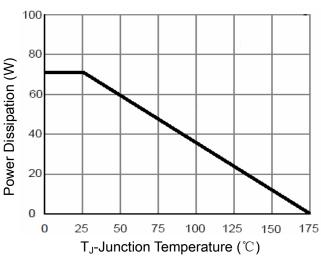


Figure 9 Power De-rating

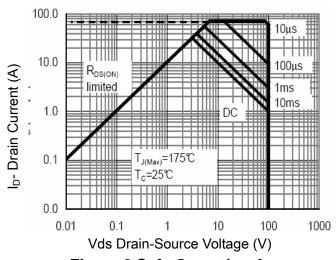
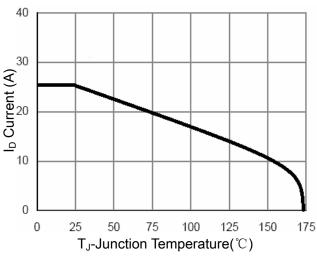


Figure 8 Safe Operation Area



**Figure 10ID Current- Junction Temperature** 

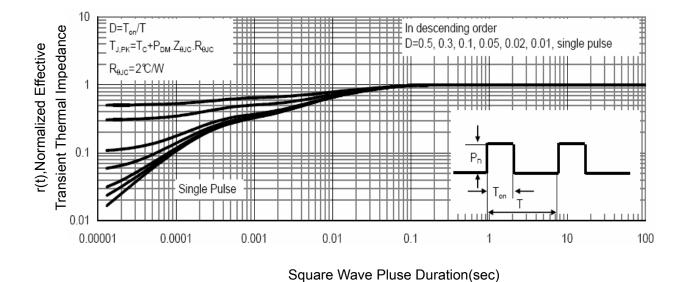
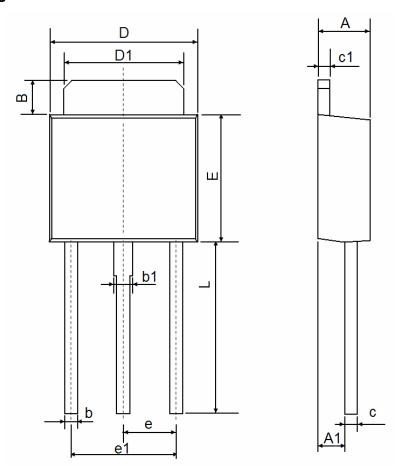


Figure 11 Normalized Maximum Transient Thermal Impedance



# **TO-251 Package Information**



Currele el	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
е	2.300 TYP		0.091	TYP	
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	



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